PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

CONVEYING PARTY DATA

Name	Execution Date
Arjang Fartash	10/02/2011
Peter Mardilovich	09/23/2011

RECEIVING PARTY DATA

Name:	Hewlett-Packard Development Company, L.P.
Street Address:	11445 Compaq Center Drive West
City:	Houston
State/Country:	TEXAS
Postal Code:	77070

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13321461

CORRESPONDENCE DATA

Fax Number: (970)778-4063 Phone: (541)715-8443 Email: terri.tuma@hp.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

via US Mail.

Correspondent Name: **Hewlett-Packard Company** Address Line 1: 3404 E. Harmony Road MS 35 Address Line 2: Intellectual Property Administration Address Line 4: Fort Collins, COLORADO 80528

NAME OF SUBMITTER: Steven L. Nichols

Total Attachments: 2

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> **PATENT REEL: 027258 FRAME: 0140**

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ntellectual Property Administrator					ALLIN ALLECA	1101
1404 E. Harmony Road Mail Stop 35			RECORD ID:		82853243	
ort Collins, Colorado 80528		-				
	ASSIGNMENT	OF PATEN	CAPPLICATION	N		
I/We the underside	nned (each) have	agreed and	hereby agree	to assign	HEWLETT-BACK	ΛĐ

I/We, the undersigned (each) have agreed and hereby agree to assign to HEWLETT-PACKARD DEVELOPMENT COMPANY, L.P., a Texas Limited Partnership having its principal place of business in Houston, Texas, (hereinafter HPDC), in furtherance of my/our obligations to the Hewlett-Packard Company and its

subsidiaries and affiliates, and do hereby assign and transfer to HPDC title and interest, including the right of priority, in, to and under an appentitled:	C, its successors and assigns, the entire right,
NANOFLAT RESISTOR	
and the invention(s) and improvement(s) set forth therein, and any a P's), divisionals, and renewals of and substitutes for said application Patent of the United States and of countries foreign thereto which reissues, or reexaminations, or extensions of said Letters Patent. I/we additionally authorize HPDC to file applications in my/ou held and enjoyed by HPDC, its successors, assigns, nominees or legaterms for which said Letters Patent respectively may be granted, reissame would have been held and enjoyed by me/us had this assignme AND I/we hereby covenant that I/we have full right to convey we have not executed and will not execute any agreement in conflict that I/we will, each time a request is made, and without undue delay, necessary or desirable to perfect the title to said invention(s) or imp Patent, to HPDC, its successors, assigns, nominees or legal representant, to testify in any legal proceedings, to sign all lawful paracontinuations, C-I-P's, reissue and foreign applications, to make all rido everything possible to aid HPDC, its successors, assigns, nomine enforce, for its or their own benefit, proper patent protection for said countries provided the expenses which may be incurred by me/us in paid by HPDC; AND I/we hereby authorize and request the Commissioner of and any official of any country or countries foreign to the United applications as aforesaid, to issue to HPDC, as assignee of the entitled applications.	for said Letters Patent, and any and all Letters may be granted thereon or therefore; and any arr name for Letters Patent in any country, to be all representatives, to the full end of the term or issued or extended, as fully and entirely as the int, and transfer not been made; the entire interest herein assigned, and that I/ herewith, and I/we further covenant and agree execute and deliver all such papers as may be rovement(s), said application and said Letters sentatives, and I/we agree to communicate to or improvement(s), said application and said bers, to execute all disclaimers and divisionals, ghtful oaths and declarations, and generally to nees and legal representatives to obtain and invention(s) or improvement(s) in any and all lending such cooperation and assistance are f Patents and Trademarks of the United States States whose duty it is to issue patents on ire right, title and interest, any and all Letters
Patent for said invention(s) or improvement(s), including any and all be issued and granted on or as a result of the application aforesaid, in I/we further authorize and direct the attorneys of record to application now identified by the Record ID and title set forth above known to them by the United States Patent and Trademark Office.	accordance with the terms of this assignment, insert the serial number and filing date of said
Ja for A	2.42 2011
Inventor's Signature	Date Assignment Signed
Arjang Fartash	od 2 /2011
Inventor's Typed Name	Date Application Signed
Inventor's Signature	Date Assignment Signed
Peter Mardilovich	
Inventor's Typed Name	Date Application Signed

Rev 09/11 (Assignment)

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HEWLETT-PACKARD COMPANY Intellectual Property Administrator 3404 E. Harmony Road Mail Stop 35 Fort Collins, Colorado 80528

PATENT APPLICATION

RECORD ID:	82853243

ASSIGNMENT OF PATENT APPLICATION

I/We, the undersigned (each) have agreed and hereby agree to assign to HEWLETT-PACKARD DEVELOPMENT COMPANY, L.P., a Texas Limited Partnership having its principal place of business in Houston, Texas, (hereinafter HPDC), in furtherance of my/our obligations to the Hewlett-Packard Company and its subsidiaries and affiliates, and do hereby assign and transfer to HPDC, its successors and assigns, the entire right, title and interest, including the right of priority, in, to and under an application for Letters Patent of the United States entitled:

title and interest, including the right of priority, in, to and under an app entitled:	
NANOFLAT RESISTOR	
Application and the invention(s) and improvement(s) set forth therein, and any are P's), divisionals, and renewals of and substitutes for said application for Patent of the United States and of countries foreign thereto which mereissues, or reexaminations, or extensions of said Letters Patent. I/we additionally authorize HPDC to file applications in my/outheld and enjoyed by HPDC, its successors, assigns, nominees or legal terms for which said Letters Patent respectively may be granted, reissame would have been held and enjoyed by me/us had this assignment. AND I/we hereby covenant that I/we have full right to convey we have not executed and will not execute any agreement in conflict that I/we will, each time a request is made, and without undue delay, encessary or desirable to perfect the title to said invention(s) or improvent, to HPDC, its successors, assigns, nominees or legal represed HPDC, or to its nominee, all known facts respecting said invention(s). Letters Patent, to testify in any legal proceedings, to sign all lawful page continuations, C-I-P's, reissue and foreign applications, to make all right do everything possible to aid HPDC, its successors, assigns, nominent enforce, for its or their own benefit, proper patent protection for said countries provided the expenses which may be incurred by me/us in paid by HPDC; AND I/we hereby authorize and request the Commissioner of and any official of any country or countries foreign to the United applications as aforesaid, to issue to HPDC, as assignee of the entity Patent for said invention(s) or improvement(s), including any and all I be issued and granted on or as a result of the application aforesaid, in I/we further authorize and direct the attorneys of record to its application now identified by the attorney docket number and title se been made known to them by the United States Patent and Trademark	and all continuations, continuations-in-part (C-I- or said Letters Patent, and any and all Letters have be granted thereon or therefore; and any or name for Letters Patent in any country, to be all representatives, to the full end of the term or sued or extended, as fully and entirely as the nt, and transfer not been made; the entire interest herein assigned, and that I/ nerewith, and I/we further covenant and agree execute and deliver all such papers as may be execute and deliver application and said Letters entatives, and I/we agree to communicate to or improvement(s), said application and said pers, to execute all disclaimers and divisionals, and the sand declarations, and generally to thees and legal representatives to obtain and invention(s) or improvement(s) in any and all lending such cooperation and assistance are if Patents and Trademarks of the United States States whose duty it is to issue patents on the right, title and interest, any and all Letters Letters Patent of the United States which may accordance with the terms of this assignment. Insert the serial number and filing date of said to forth above as soon as the same shall have
Inventor's Signature	Date Assignment Signed
Arjang Fartash	
Inventor's Typed Name	Date Application Signed
R Mart	September 23, 2011 Date Assignment Signed September 23, 2011 Date Application Signed
Inventor's Signature	Date Assignment Signed
Peter Mardilovich Inventor's Typed Name	Date Application Signed
inventor o 13pou numo	Date Application digited

Rev 07/11 (Assignment)

RECORDED: 11/18/2011

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